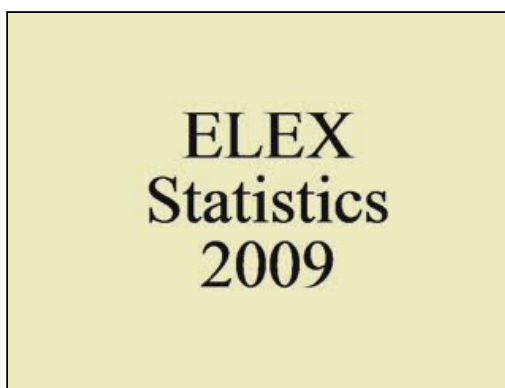


## From Editor-in-Chief

In starting 2010 publication activity, I would like to proudly report the successive growth of our all-electronic and peer-reviewed journal, The IEICE Electronics Express (ELEX). Many of the readers have already known that five years have passed since the first issue of ELEX was published in April, 2004, and the 5th Anniversary Special Issue was published as vol. 6, no. 11, in June 10, 2009, by inviting six experts in the field of photonics, microwave and millimeter-wave, and integrated circuits. I am very pleased to know that numbers of accessing to and downloading from our ELEX website were significantly increased. In the volume 6 for the year 2009 we presented 24 issues. The total of 271 papers were published. The contributors are quite international. Namely, the number of countries/areas where the first authors of published papers belong is as large as 24. As of December 21, 2009, the number of submissions totally amounts to 890. It was 65% increase over the previous year. The rate of acceptance is approximately 35%. The total number of 343,831 was accessed to our ELEX website and 127,197 papers were downloaded from the website in 2009.

We understand such international recognition of ELEX is owing to the fact that papers are rapidly published: The period from paper submission (the moment of uploading manuscript files by authors) to publishing is 10 calendar days in the fastest case, 65.2 days on the average. This good record was achieved by the collaboration of reviewers and authors, both of whom are conscious of the importance of rapid publication. In addition the endeavor of staffs in the IEICE Publishing Office and the Editorial Committee members should not be forgotten.



**Fig. 1.** Statistics of ELEX in 2009. A movie file is embedded. Adobe Reader 6.0 (or later) and Quick Time Player 6.0 (or later), both are freewares, should be installed for playing the movie.

Another advantage of ELEX also comes from the nature of all-electronic publication. The authors can present their results in impressive manners using multicolor figures or movie files. You can find a large number of papers with multicolor figures. On the other hand, the usage of movie files is not yet fully exploited. Only one paper with movie files embedded has already been published. We hope that the number of such papers will increase in the subsequent volumes. Figure 1 is attached one demonstration of movie files.

Furthermore for the benefit of the readers it was determined that main bodies of the respective files, provided in PDF formats, are accessible without identification process for now. The readers are, however, kindly advised to consider registration at IEICE website for receiving free e-mail alerts, which provide registered users with hyperlinks to papers in the latest issues.

I would also like to give you several announcements about activities in 2009.

- First, the exemption from article charge payment program continues; authors can apply to the program, and ELEX editorial committee judges the paper quality. Not more than twenty papers earn this privilege.
- Second, as has already been announced on the website, I would like to inform you that ELEX has been selected for coverage in Thomson Scientific (formerly known as Thomson ISI) products and services. Beginning with vol. 2, no. 1 2005, this publication will be indexed and abstracted in:
  - Science Citation Index Expanded (also known as SciSearch®)
  - Journal Citation Reports/Science Edition
  - Current Contents®/Engineering Computing and TechnologyIn addition, the first impact factor (IF) for ELEX was released in 2008, and the current IF for 2009 is 0.482.
- Third, we ELEX Editorial Committee are pleased to decide ELEX Best Paper Award 2008, which was given to the best quality and valuable paper.

Finally, I would like to make an important announcement about the change of manuscript submission qualifications for ELEX. As has already been announced on the website, from January 1, 2010, at least one of the authors must be an IEICE member when the manuscript is submitted for reviewing except for invited papers. I thank you very much in advance for your understanding and cooperation.

We know that your suggestions and comments are quite useful for improving ELEX services and for making ELEX more attractive for all engineers in advanced electronics. We appreciate any kind of suggestions and comments.

We continue to make every effort so that ELEX plays a more important role in the accelerated progress of electronics and related science serving for the welfare of humankind.



**Kohroh Kobayashi**  
Editor-in-Chief  
IEICE Electronics Express

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